

Infrared LED

... designed for applications requiring high power output, low drive power and very fast response time. This device is used in industrial processing and control, light modulators, shaft or position encoders, punched card readers, optical switching, and logic circuits. It is spectrally matched for use with silicon detectors.

- High-Power Output — 4 mW (Typ) @ $I_F = 100$ mA, Pulsed
- Infrared-Emission — 940 nm (Typ)
- Low Drive Current — 10 mA for 450 μ W (Typ)
- Popular TO-18 Type Package for Easy Handling and Mounting
- Hermetic Metal Package for Stability and Reliability

MLED930

**INFRARED
LED
940 nm**

CONVEX
LENS



**CASE 209-01
METAL**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V_R	6	Volts
Forward Current — Continuous	I_F	60	mA
Forward Current — Peak Pulse (PW = 100 μ s, d.c. = 2%)	I_F	1	A
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C (Note 1)	P_D	250 2.27	mW mW/ $^\circ\text{C}$
Operating Temperature Range	T_A	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Fig. No.	Symbol	Min	Typ	Max	Unit
Reverse Leakage Current ($V_R = 3$ V)	—	I_R	—	2	—	nA
Reverse Breakdown Voltage ($I_R = 100$ μ A)	—	$V_{(BR)R}$	6	20	—	Volts
Forward Voltage ($I_F = 50$ mA)	2	V_F	—	1.32	1.5	Volts
Total Capacitance ($V_R = 0$ V, $f = 1$ MHz)	—	C_T	—	18	—	pF

OPTICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Total Power Output (Note 2) ($I_F = 60$ mA, dc) ($I_F = 100$ mA, PW = 100 μ s, duty cycle = 2%)	3, 4	P_O	— 1	2.5 4	— —	mW
Radiant Intensity (Note 3) ($I_F = 100$ mA, PW = 100 μ s, duty cycle = 2%)	—	I_O	—	1.5	—	mW/ steradian
Peak Emission Wavelength	1	λ_P	—	940	—	nm
Spectral Line Half Width	1	$\Delta\lambda$	—	40	—	nm

Notes: 1. Printed Circuit Board Mounting

2. Power Output, P_O , is the total power radiated by the device into a solid angle of 2π steradians. It is measured by directing all radiation leaving the device, within this solid angle, onto a calibrated silicon solar cell.

3. Irradiance from a Light Emitting Diode (LED) can be calculated by:

I_e where H is irradiance in mW/cm²; I_e is radiant intensity in mW/steradian;

$H = \frac{I_e}{d^2}$
 d^2 is distance from LED to the detector in cm.

MLED930

TYPICAL CHARACTERISTICS

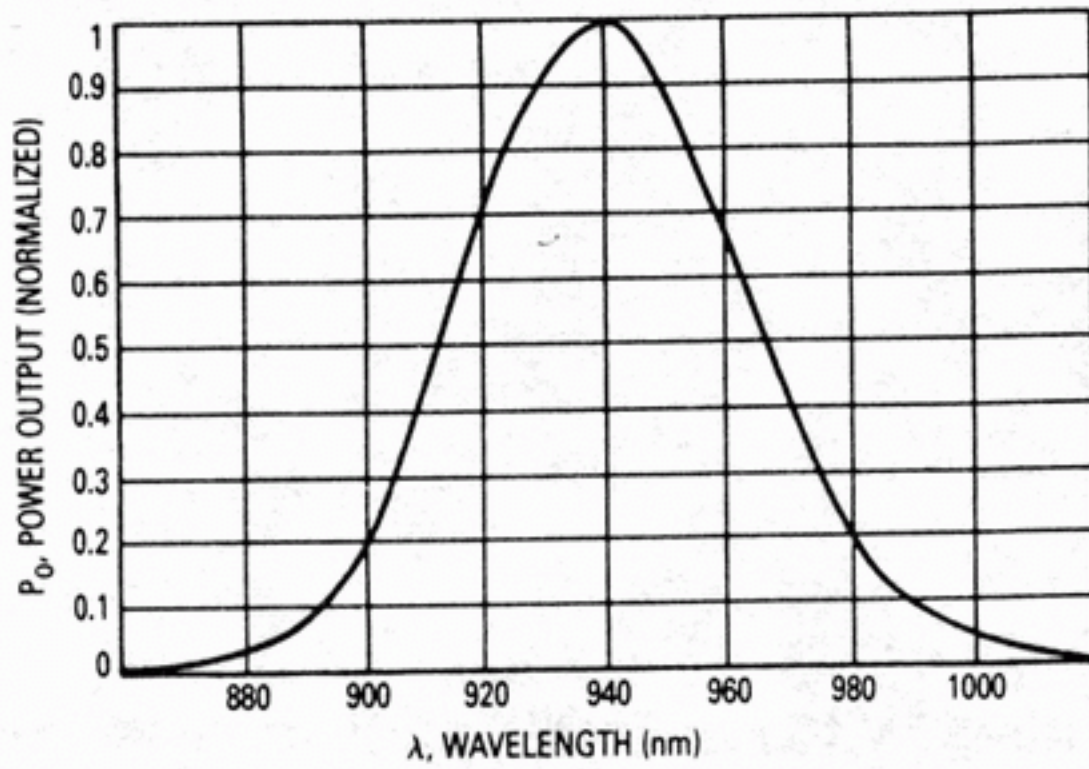


Figure 1. Relative Spectral Output

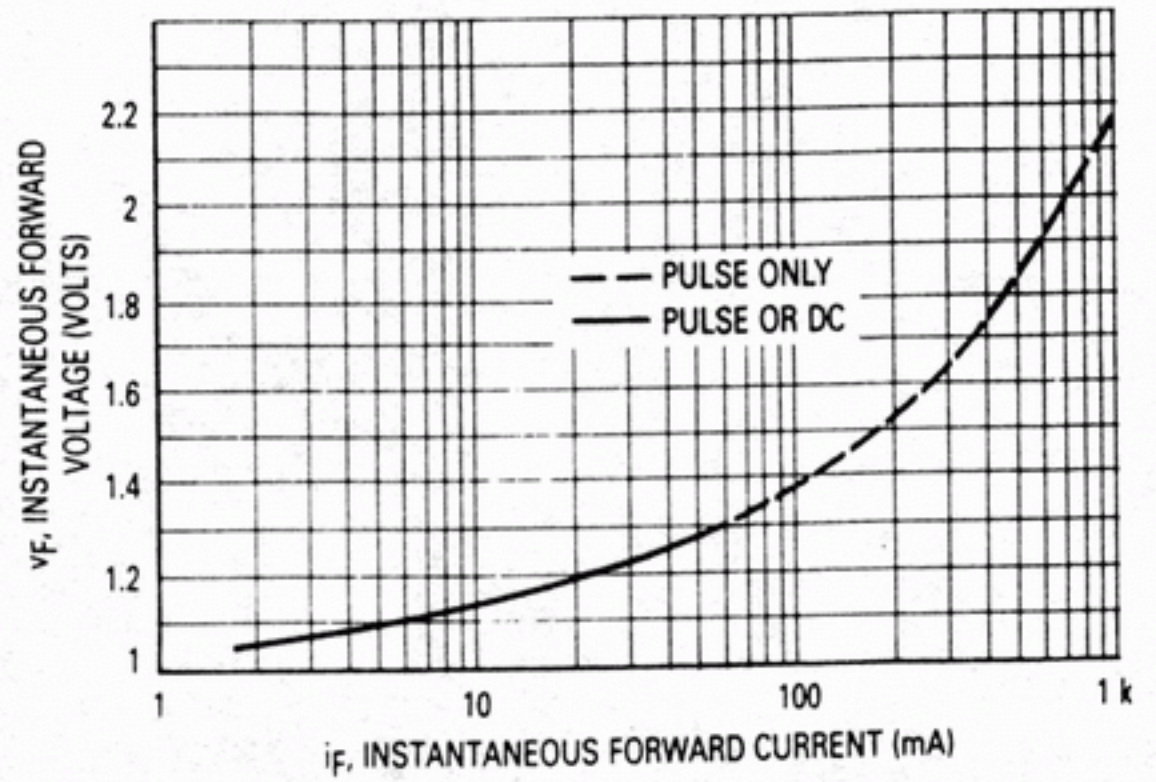


Figure 2. Forward Characteristics

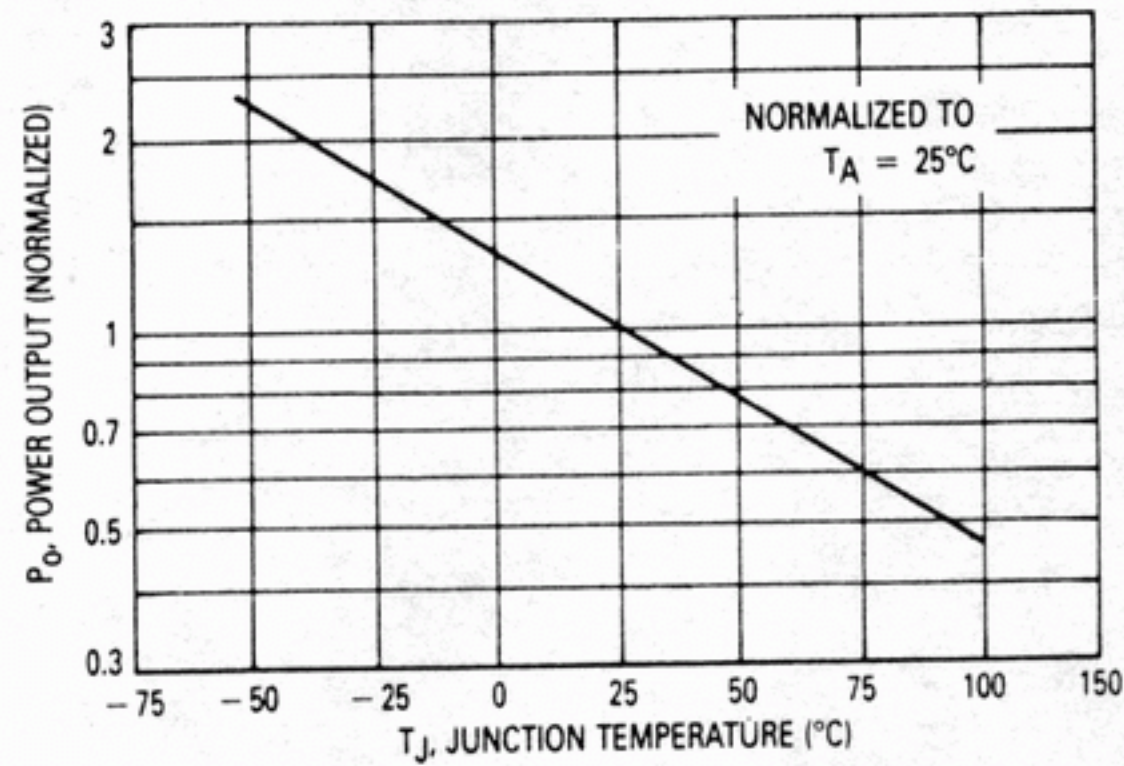


Figure 3. Power Output versus Junction Temperature

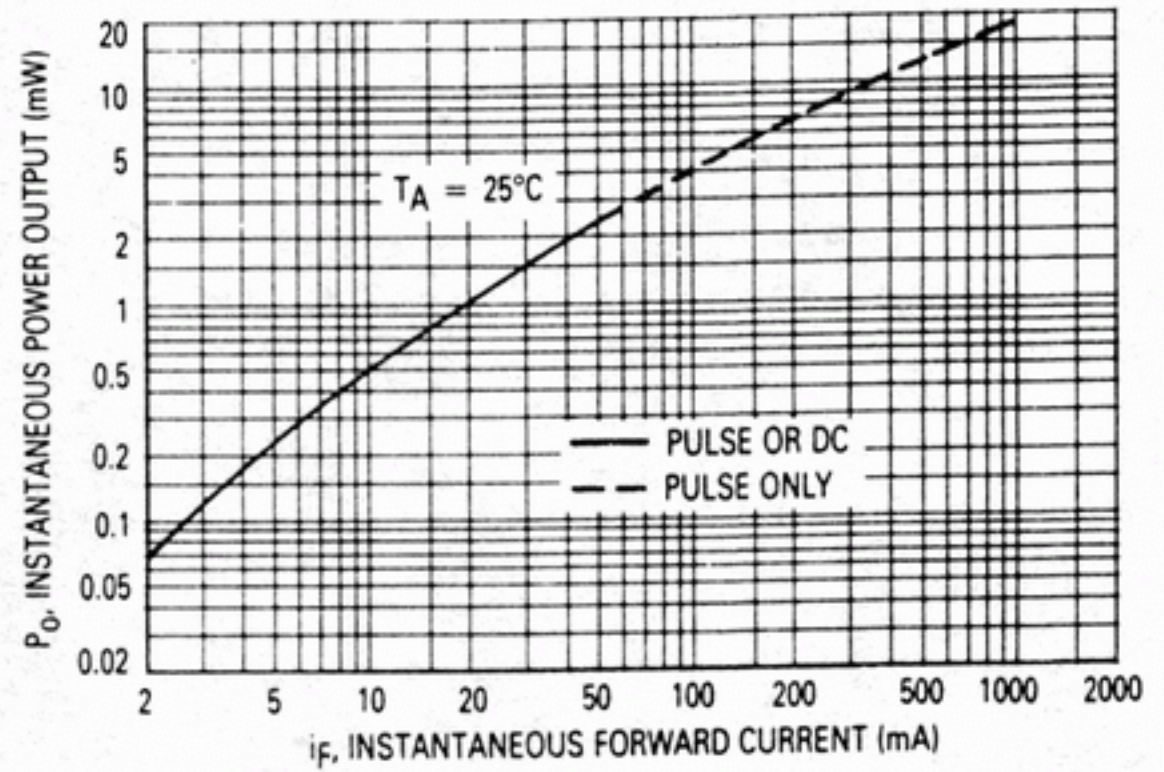


Figure 4. Instantaneous Power Output versus Forward Current

OUTLINE DIMENSIONS

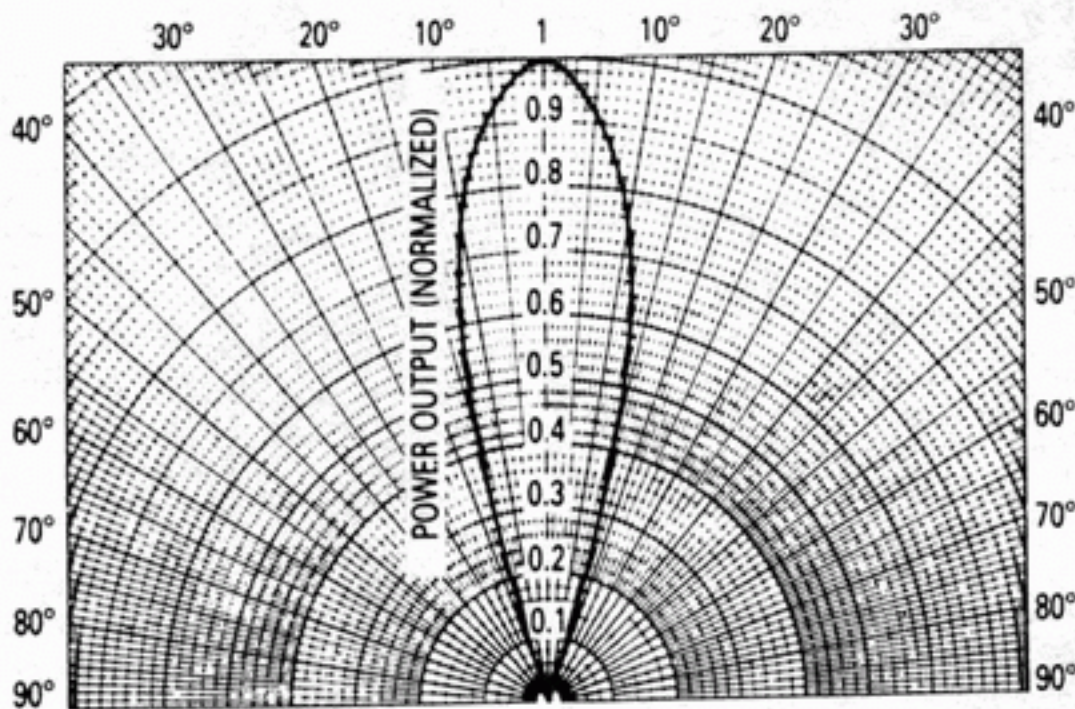


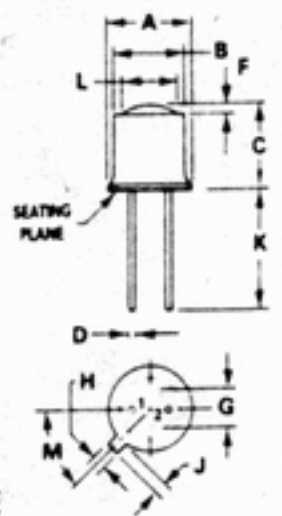
Figure 5. Spatial Radiation Pattern

NOTES:

- PIN 2 INTERNALLY CONNECTED TO CASE
- LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.31	5.84	0.209	0.230
B	4.52	4.95	0.178	0.195
C	5.08	6.35	0.200	0.250
D	0.41	0.48	0.016	0.019
F	0.51	1.02	0.020	0.040
G	2.54 BSC		0.100 BSC	
H	0.99	1.17	0.039	0.046
J	0.84	1.22	0.033	0.048
K	12.70	—	0.500	—
L	3.35	4.01	0.132	0.158
M	45° BSC		45° BSC	

STYLE 1:
PIN 1. ANODE
2. CATHODE



CASE 209-01
METAL